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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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Part No. P522304

Broadband FR4 Embedded Cellular Antenna

850 / 900 / 1800 / 1900 / 2100 MHz

Supports: Broadband LTE (OCTA-BAND), LTE CAT-M, NB-IoT, SigFox, LoRa, Cellular LPWA, RPMA, Firstnet



Ethertronics' Broadband Embedded Cellular antenna utilizes Isolated Magnetic Dipole™ (IMD) technology which address the challenges facing today's product designers. IMD's high performance and isolation characteristics offer better connectivity and minimal interference.

Stays in Tune

IMD antenna technology provides superior RF field containment, resulting in less interaction with surrounding components. Ethertronics IMD antennas resist detuning; providing a robust radio link regardless of the usage position

Ethertronics antennas use patented IMD technology in many antenna configurations to provide high performance. IMD antennas requires a smaller design keep-out area, carry lower program development risk which yields a quicker time-to-market, without sacrificing RF performance.

Electrical Specifications

Typical Characteristics, on 50 x 110 mm PCB

Frequency	824 - 960 MHz	1710 - 2170 MHz	
Efficiency	62%	55%	
VSWR	2.5:1 max	2.7:1 max	
Peak Gain	0 dBi	0.7 dBi	
Polarization	Linear		
Power Handling	2 Watts CW		
Radiation Pattern	Omni-directional		
Feed Point Impedance	50 ohms unbalanced		

Mechanical Specifications & Ordering Part Number

Ordering Part #	P522304
Dimensions (mm)	35.0 x 9.0 x 3.2
Weight (grams)	2.1
Mounting	SMT (P&P)
Packaging	1,120 pcs/reel; 5,600 pcs/box
Demo Board	P522304-02

Broadband FR4 Embedded Cellular Antenna

Low Band 824 – 960 MHz High Band 1710 - 2170 MHz

KEY BENEFITS

Reduced Costs and Time-to-Market

Standard antenna eliminates design fees and cycle time associated with a custom solution; getting products to market faster.

Greater Flexibility with Unique Form Factors

Ethertronics' technology helps you deliver more advanced ergonomic designs without adverse impact on product performance.

Reliability

Comply with latest RoHS requirements

APPLICATIONS

- Medical applications
 Home
 Automotive
 Healthcare
 Point of Sale
 - automationTrackingSmartCellularautomationCellular3G Systems
- M2M,
 Industrial
 devices
- devices
 IoT
- Firstnet

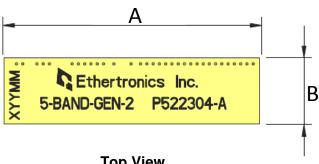
5/14/2018 Proprietary www.ethertronics.com



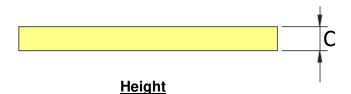
Antenna Dimensions

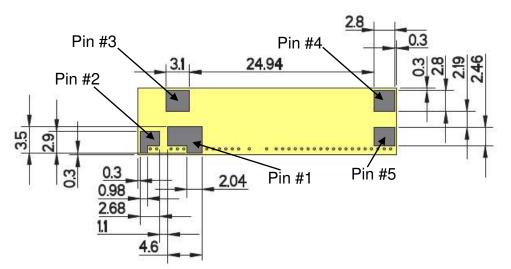
Typical antenna dimensions (mm)

Part Number	A (mm)	B (mm)	C (mm)
P522304	35.0 ± 0.3	9.0 ± 0.2	3.2 ± 0.3



Top View





Pin Descriptions

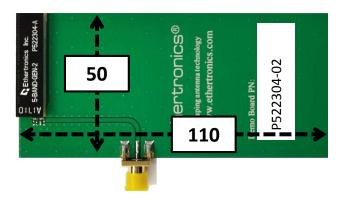
Pin#	Description
1	Feed
2	Ground
3	Dummy Pad
4	Dummy Pad
5	Low Band Tuning

Bottom View

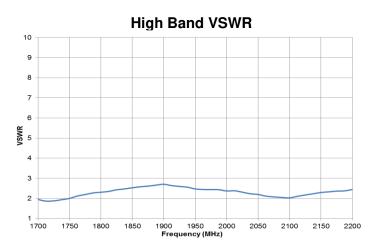


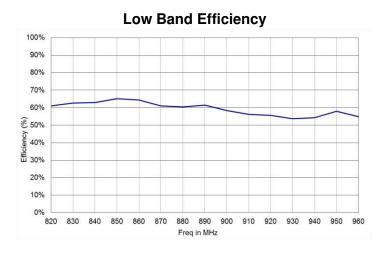
VSWR and Efficiency Plots (Off-Ground)

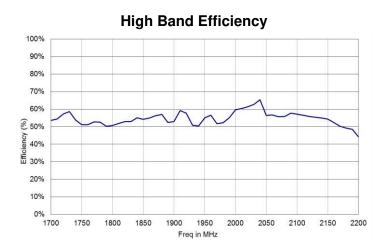
Typical Performance on 50 x 110 mm PCB



Low Band VSWR 10 5 880 900 Frequency (MHz) 820 840 860 940





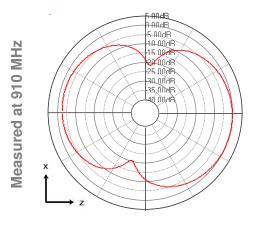


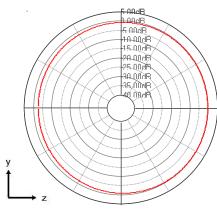


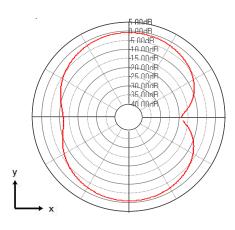
Antenna Radiation Patterns

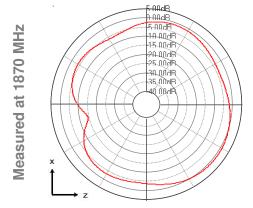
Typical Performance on 50 x 110 mm PCB Measured @ 910, 1870 MHz

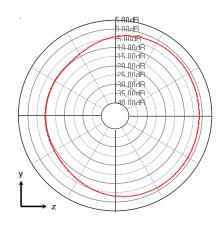


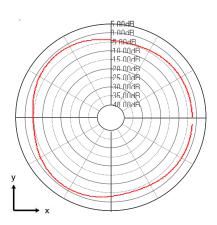








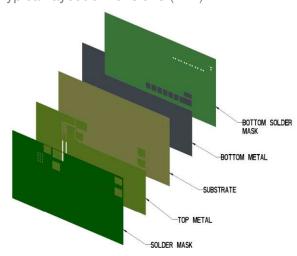






Antenna Layout (On-Ground)

Typical layout dimensions (mm)



* VIAS: Diam. 0.2mm, (no vias on transmission lines). Via holes must be covered by solder mask

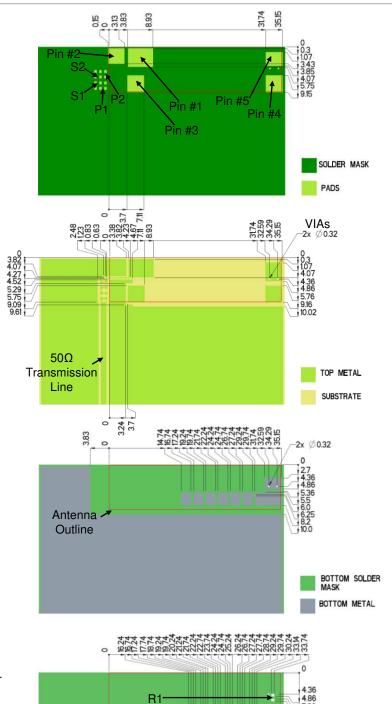
Pin Descriptions

Pin#	Description
1	Feed
2	Ground
3	Dummy Pad
4	Dummy Pad
5	Low Band Tuning

Matching & Tuning Component Values

Component	Value	Tolerance
P1	3.6nH	±0.05nH
S1	1.2pF	±0.05pF
S2	15nH	±0.3nH
P2	1.8pF	±0.05pF
R1 – R7	DNI	N/A

Default Pi Matching Network values and (R1- R7) tuning instructions can be found under Antenna Matching Structure..



BOTTOM SOLDER MASK

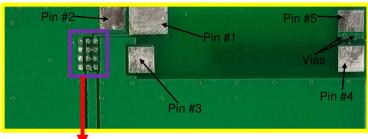


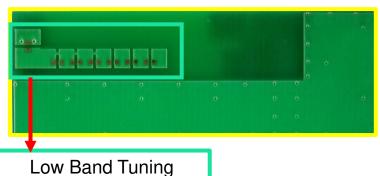
Antenna Matching Structure

Typical matching values on 50 x 110 mm PCB

Demo Board Front View

Demo Board Back View

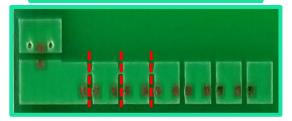




Antenna Matching

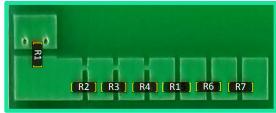
(Antenna Matching): pads are directly inline with the antenna feed trace.

Tune Low Band Higher (Cut Bridge Trace)



*Cut Trace between pads shifts resonant frequency higher

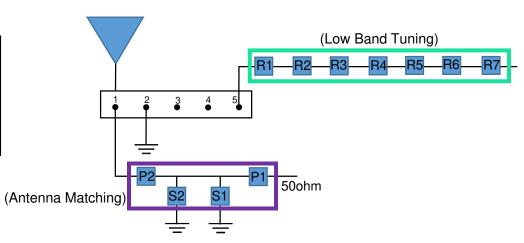
Tune Low Band Lower $(Add 0\Omega)$



*Bridging gaps with 0 ohm resistors shifts resonant frequency lower

Pin Descriptions

Pin#	Description
1	Feed
2	Ground
3	Dummy Pad
4	Dummy Pad
5	Low Band Tuning



	P1	S1	S2	P2	(R1 - R7)
Default Matching	3.6nH	1.2pF	15nH	1.8pF	DNI
Tolerance	±0.05nH	± 0.05pF	±0.3nH	± 0.05pF	N/A



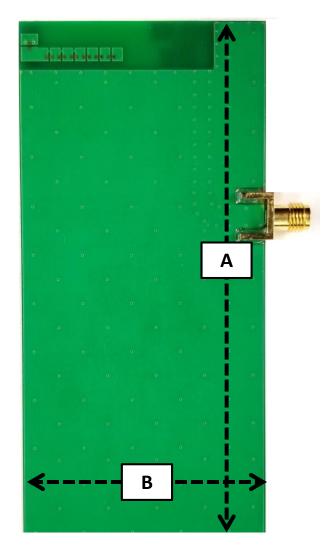
Antenna Demo Board

Demo Board Front View/Back View

Part Number	A (mm)	B (mm)	C (mm)
P522304-02	110	50.0	15.0



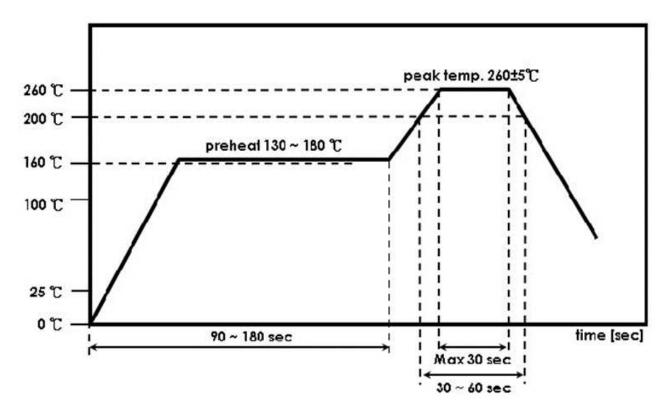
Front View



Back View

Recommended Reflow Soldering Profile

The recommended method for soldering the antenna to the board is forced convection reflow soldering. The following suggestions provide information on how to optimize the reflow process for the FR4 antenna:



^{*}Adjust the reflow duration to create good solder joints without raising the antenna temperature beyond the allowed maximum of 260° C.